



US00D328074S

# United States Patent [19]

Yamazaki et al.

[11] Patent Number: **Des. 328,074**

[45] Date of Patent: **\*\* Jul. 21, 1992**

[54] **HEADPHONE**

[75] Inventors: **Akira Yamazaki, Saitama; Ohshi Miyashita, Tokyo, both of Japan**

[73] Assignee: **Sony Corporation, Tokyo, Japan**

[\*\*] Term: **14 Years**

[21] Appl. No.: **651,904**

[22] Filed: **Feb. 7, 1991**

[30] **Foreign Application Priority Data**

Aug. 7, 1990 [JP] Japan ..... 2-26721

[52] U.S. Cl. .... **D14/205**

[58] Field of Search ..... **D14/205-207, D14/223, 299, 220; 381/25, 158, 183, 189, 58; 379/40, 444; 181/129**

[56] **References Cited**

**U.S. PATENT DOCUMENTS**

2,593,892 4/1952 Kindel ..... 181/129

**OTHER PUBLICATIONS**

High Fidelity Magazine, Sep. 1987, p. 9, "Sony" Headphones.

*Primary Examiner*—Charles A. Rademaker  
*Attorney, Agent, or Firm*—Lewis H. Eslinger; Jay H. Maioli

[57] **CLAIM**

The ornamental design for a headphone, as shown and described.

**DESCRIPTION**

FIG. 1 is a top, front and right-side perspective view of a headphone, showing our new design;

FIG. 2 is a top, front and right-side perspective view thereof, shown with head band in the expanded position;

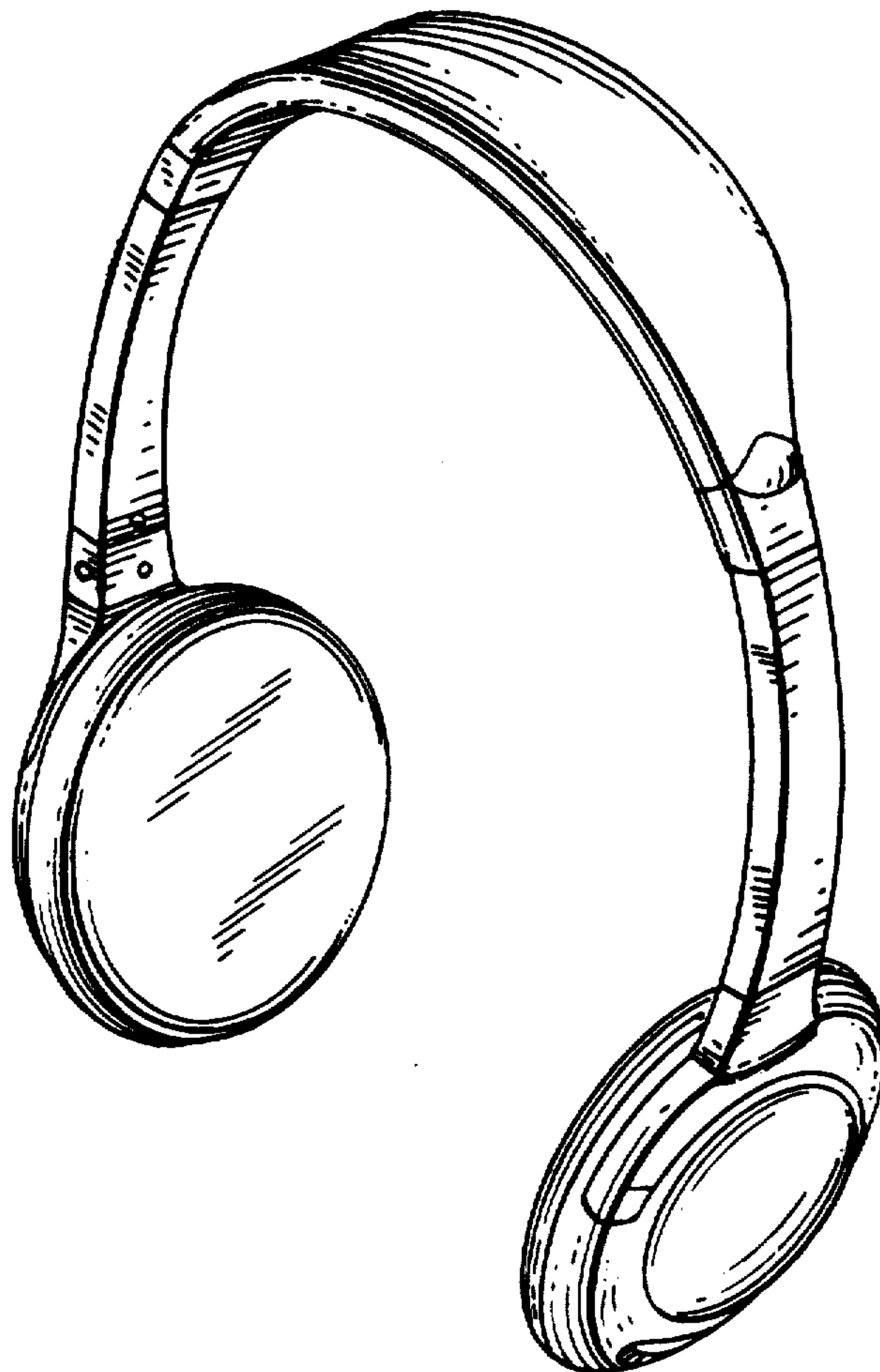
FIG. 3 is a front elevational view thereof;

FIG. 4 is a rear elevational view thereof;

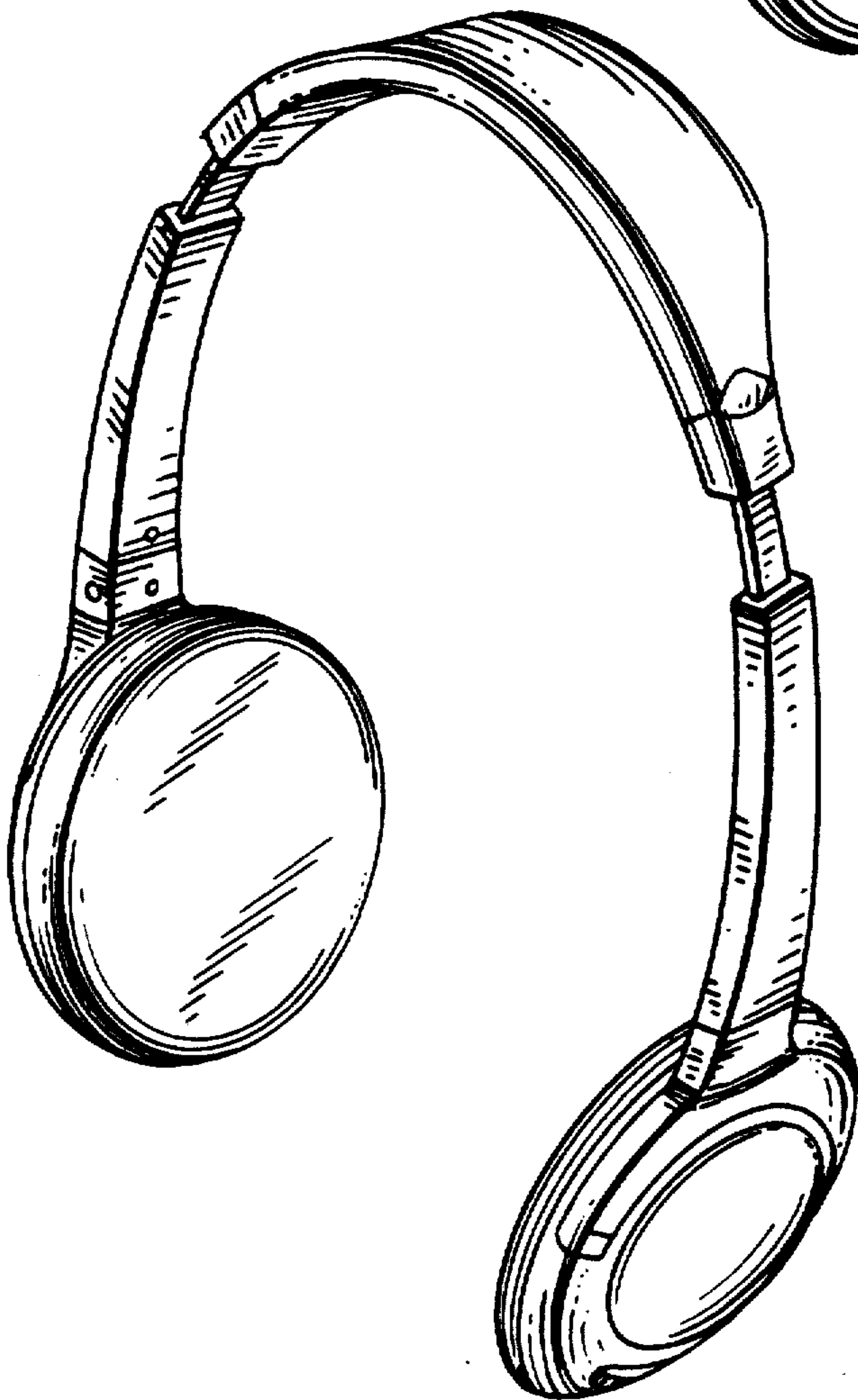
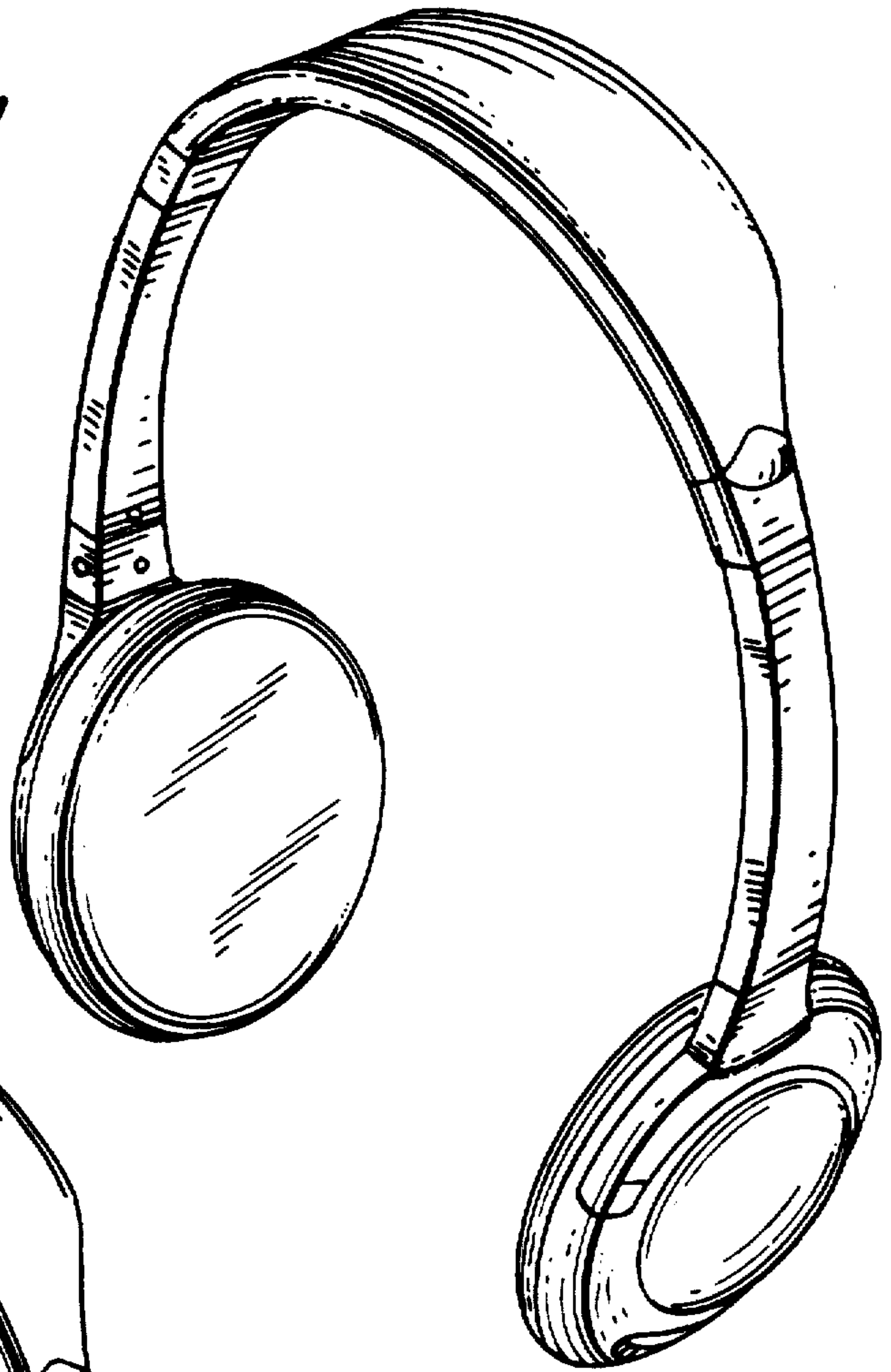
FIG. 5 is a right-side elevational view thereof, the left-side being a mirror image;

FIG. 6 is a top plan view thereof; and,

FIG. 7 is a bottom plan view thereof.

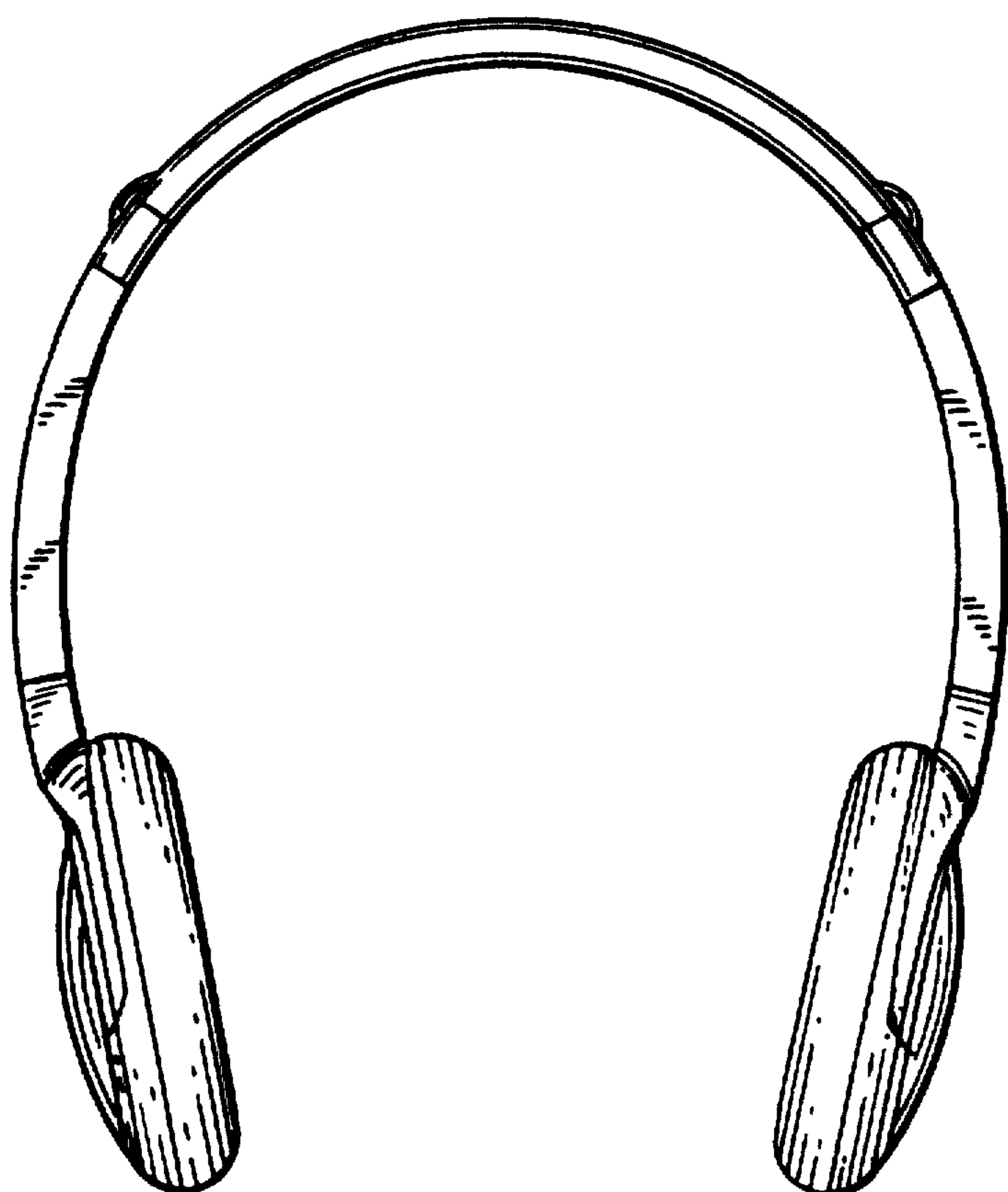
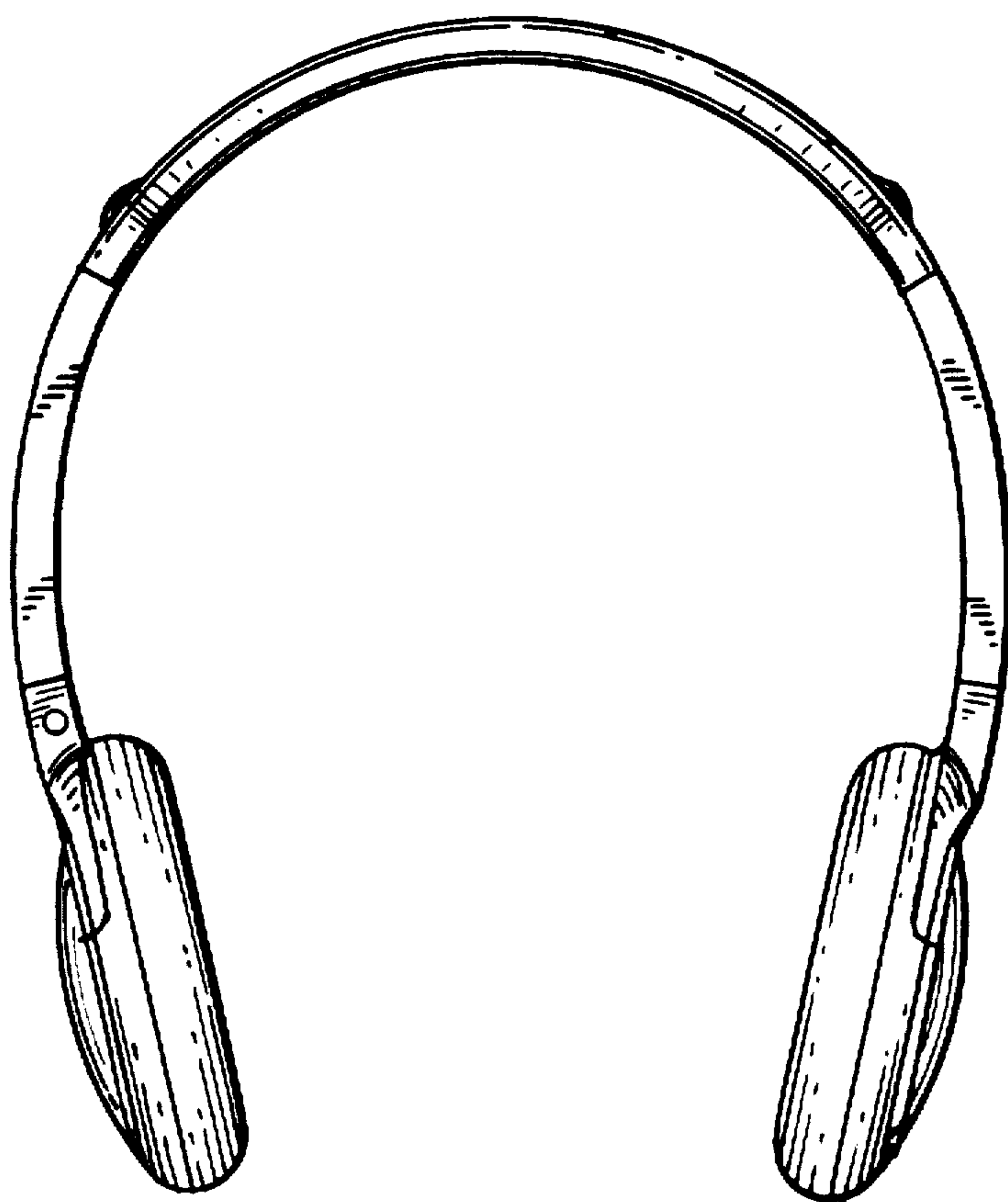


*FIG. 1*



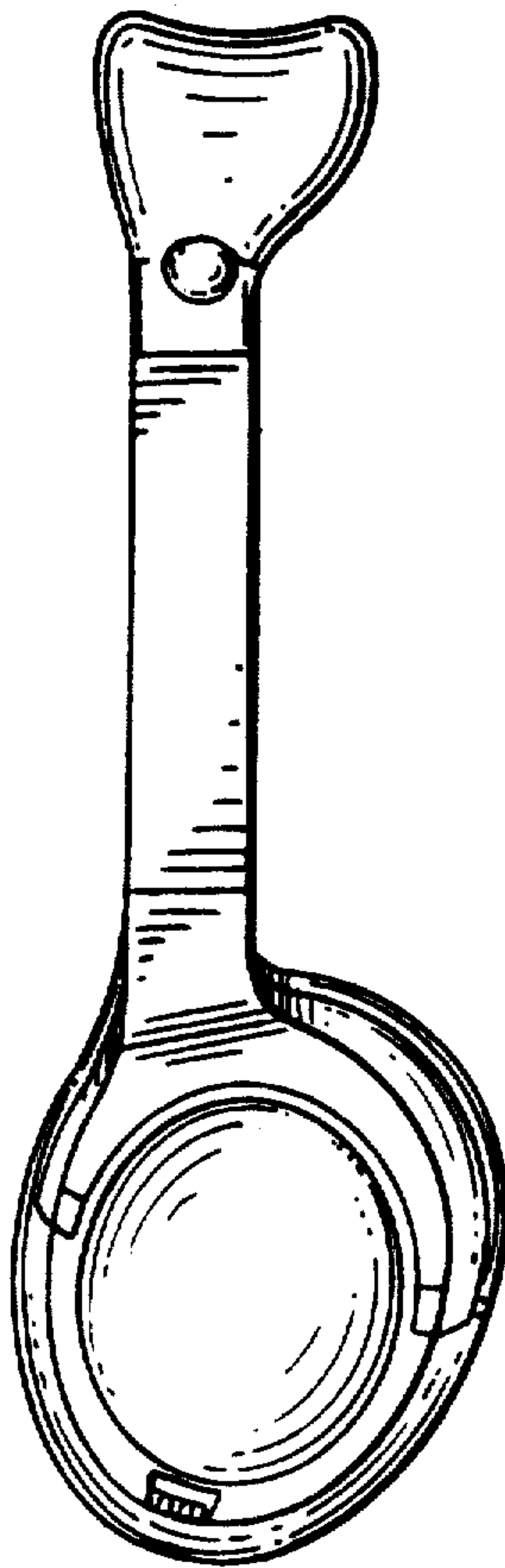
*FIG. 2*

*FIG. 3*

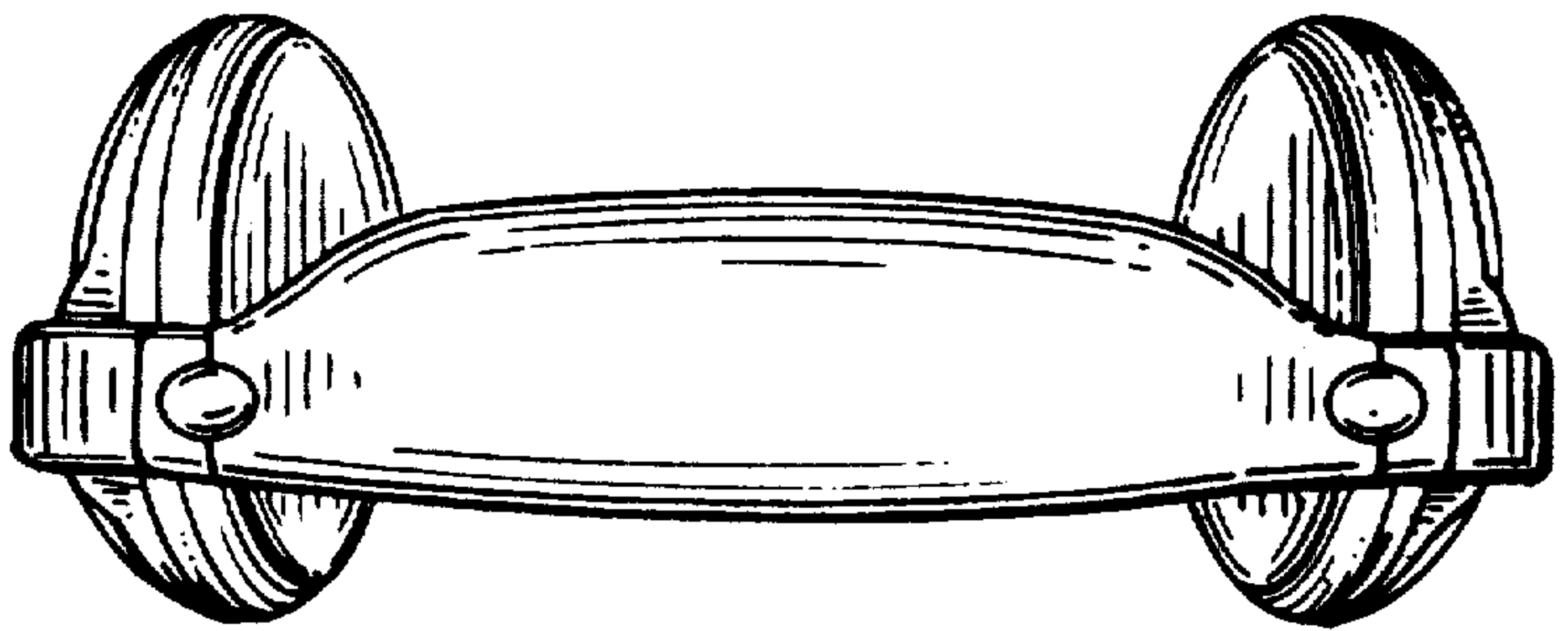


*FIG. 4*

*FIG. 5*



*FIG. 6*



*FIG. 7*

